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60V N-Channel PowerTrench^o MOSFET

General Description

These N Channel Logic Level MOSFET have been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

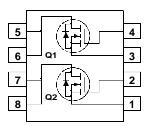
The MOSFET feature faster switching and lower gate charge than other MOSFET with comparable RDS(on) specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

SO-8

Features

- 3.5 A, 60 V. $R_{DS(ON)} = 0.100\Omega$ @ V_{GS} = 10 V $R_{DS(ON)} = 0.200\Omega$ @ V_{GS} = 4.5V
- Optimized for use in switching DC/DC converters
 with PWM controllers
- Very fast switching
- Low gate charge.



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DSS}	Drain-Sourc	Source Voltage		60	V
V _{GSS}	Gate-Sourc	e Voltage		±20	V
l _D	Drain Curre	nt – Continuous	(Note 1a)	3.5	A
		– Pulsed		10	
P₀	Power Dissi	pation for Single Operation	ON (Note 1a)	2	W
			(Note 1b)	1.6	
			(Note 1c)	1.0	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C
Therma	I Charact	teristics			
$R_{\theta JA}$	Thermal Re	hermal Resistance, Junction-to-Ambient		78 (steady state), 50 (10 sec) °C/W
$R_{\theta JA}$	Thermal Re	sistance, Junction-to-Am	bient (Note 1c)	135	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case		Se (Note 1)	40	°C/W
Packag	e Marking	g and Ordering I	nformation		·
Device Marking		Device	Reel Size	Tape width	Quantity
FDS9945					

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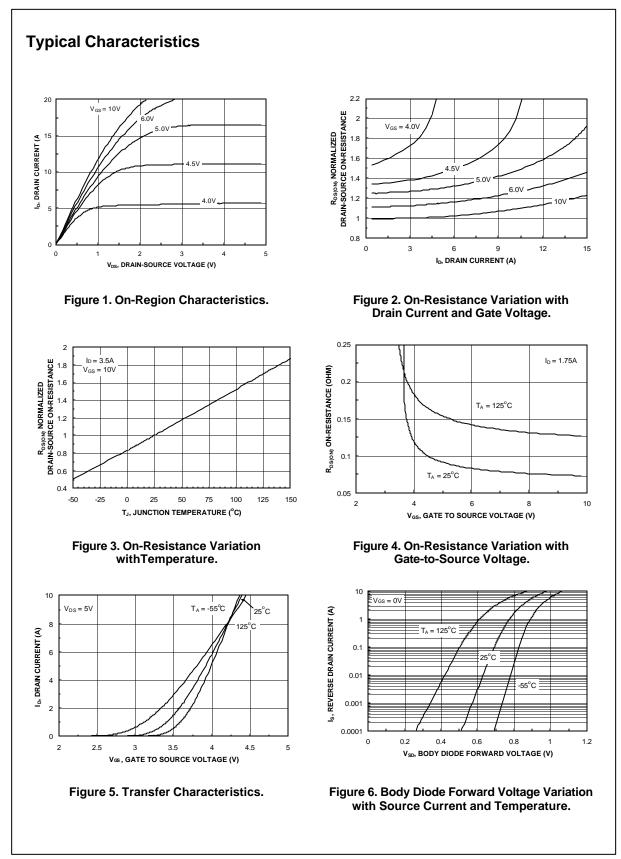
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	I				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	60			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		62.5		mV/ºC
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -20 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	2.5	3	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-6		mV/⁰C
R _{DS(on)}	Static Drain–Source On–Resistance			74 103 126	100 200 170	mΩ
D(on)	On–State Drain Current	$V_{GS} = 10 \text{ V}, = V_{DS} = 30 \text{ V}$	10			Α
g fs	Forward Transconductance	$V_{DS} = 5V$, $I_D = 3.5 A$		8.6		S
Dvnamio	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 30 V$, $V_{GS} = 0 V$,		420		pF
Coss	Output Capacitance	f = 1.0 MHz		48		pF
Crss	Reverse Transfer Capacitance	1		20		pF
Switchir	g Characteristics (Note 2)	•	•		•	
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 30 V$, $I_D = 1 A$,		7	14	ns
tr	Turn–On Rise Time	$V_{GS} = 10 V$, $R_{GEN} = 6 \Omega$		4.3	8.6	ns
t _{d(off)}	Turn–Off Delay Time	1		19	34	ns
t _f	Turn–Off Fall Time	1		3	6	ns
Qg	Total Gate Charge	$V_{DS} = 30 V$, $I_D = 3.5 A$,		8	13	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		4		nC
∽ys	Gate–Drain Charge]		2.5		nC
Q _{gd}	ource Diode Characteristics	and Maximum Ratings				
Q _{gd}	ource Diode Characteristics				2.1	Α

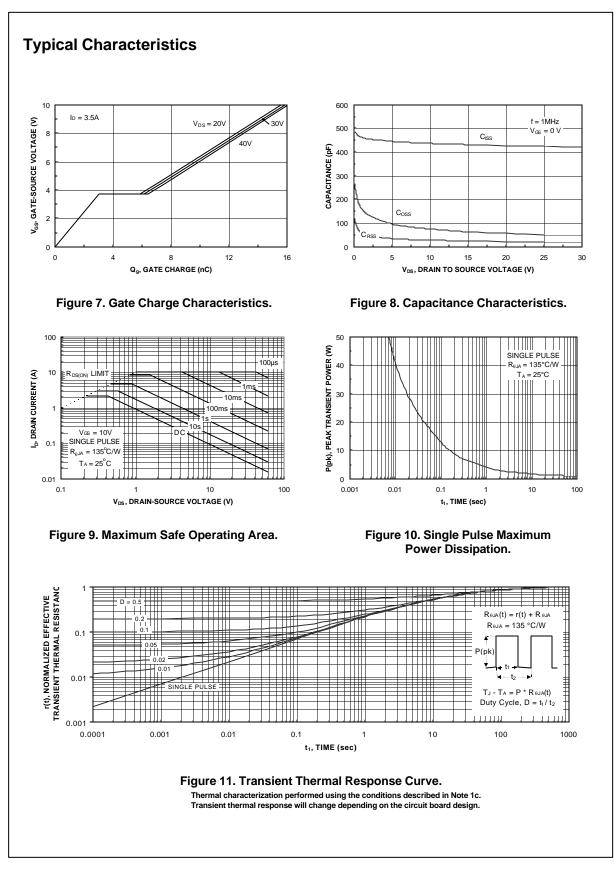
Scale 1 : 1 on letter size paper

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2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDS9945 Rev B(W)





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